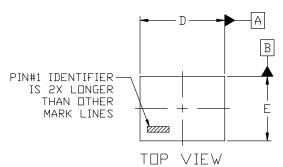




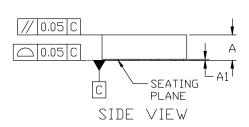
UQFN10 2.10x1.60x0.63, 0.50P CASE 523AD ISSUE O

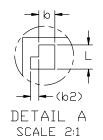
DATE 02 JAN 2024



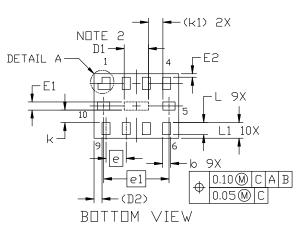


- DIMENSIONING AND TOLERANCING CONFORM TO ASME Y14.5-2018.
- 2. ALL DIMENSION ARE IN MILLIMETERS.
- 3. PRESENCE OF CENTER PAD IS PACKAGE SUPPLIER DEPENDENT. IF PRESENT IT IS NOT INTENDED TO BE SOLDERED AND HAS A BLACK DXIDE FINISH.





DIM	MILLIMETERS			
	MIN.	N□M.	MAX.	
А	0,58	0.63	0.68	
A1	0.00		0.05	
Ø	0.15	0.20	0.25	
29	0.05			
D	2.00	2.10	2.20	
D1	0.55	0.60	0.65	
D2	0,20 REF.			
E	1,50	1.60	1.70	
E1	0.15	0.20	0.25	
E2	0.00		0.15	
ω	0.50 BSC			
e1	1.62 BSC			
X	0.20			
k1	0.36 REF.			
اـ	0,25	0.30	0.35	
L1	0.25		0.42	



(0.110) - KEEPDUT ZONE, ND EXPOSED TRACES OR VIAS ALLOWED
1.120 0.560 0.560 0.350) 10X
0.500 - (0.250) 10x

RECOMMENDED MOUNTING FOOTPRINT*

*FOR ADDITIONAL INFORMATION ON OUR P6-FREE STRATEGY AND SOLDERING DETAILS, PLEASE DOWNLOAD THE ON SEMICONDUCTOR SOLDERING AND MOUNTING TECHNIQUES REFERENCE MANUAL, SOLDERRM/D.

DOCUMENT NUMBER:	98AON60477H	Electronic versions are uncontrolled except when accessed directly from the Document Repository. Printed versions are uncontrolled except when stamped "CONTROLLED COPY" in red.		
DESCRIPTION:	UQFN10 2.10x1.60x0.63, 0.50P		PAGE 1 OF 1	

onsemi and ONSemi are trademarks of Semiconductor Components Industries, LLC dba onsemi or its subsidiaries in the United States and/or other countries. onsemi reserves the right to make changes without further notice to any products herein. onsemi makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does onsemi assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. onsemi does not convey any license under its patent rights nor the rights of others.